

NA Regional Summit
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2020 Vision of Engineering Analysis and Simulation
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The next revolution in simulation

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LMS International



The industry is facing faster and broader change (IBM CEO Survey 2008)

Sustainability



Radical new product concepts



“80% of the future innovation will be software-driven or electronics-based”

McKinsey & Co



Business Globalization

“Work will move where the talent is”

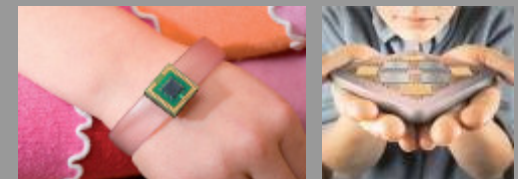
“The opportunity is in the raising buying power of 1.2 billion new consumers by 2030.”

Expansive growth of web applications

*1 million businesses
...1 billion users
...1 trillion devices*

New technology

- New materials
- Nano technologies
- Adaptronics



The “Next” product innovation agenda

Engineering the “passion” in a “green” environment

“ZERONIZE”

Minimal energy consumption

Reduced emissions

95%+ recyclable

Close to no casualties



Smart
systems
drive
80% of the
future
innovations

“MAXIMIZE”

Full driving pleasure

Optimal comfort

Distinct sound quality

Power and speed



Demands for a “Next” generation development process Based on 1D, 3D CAE and Test

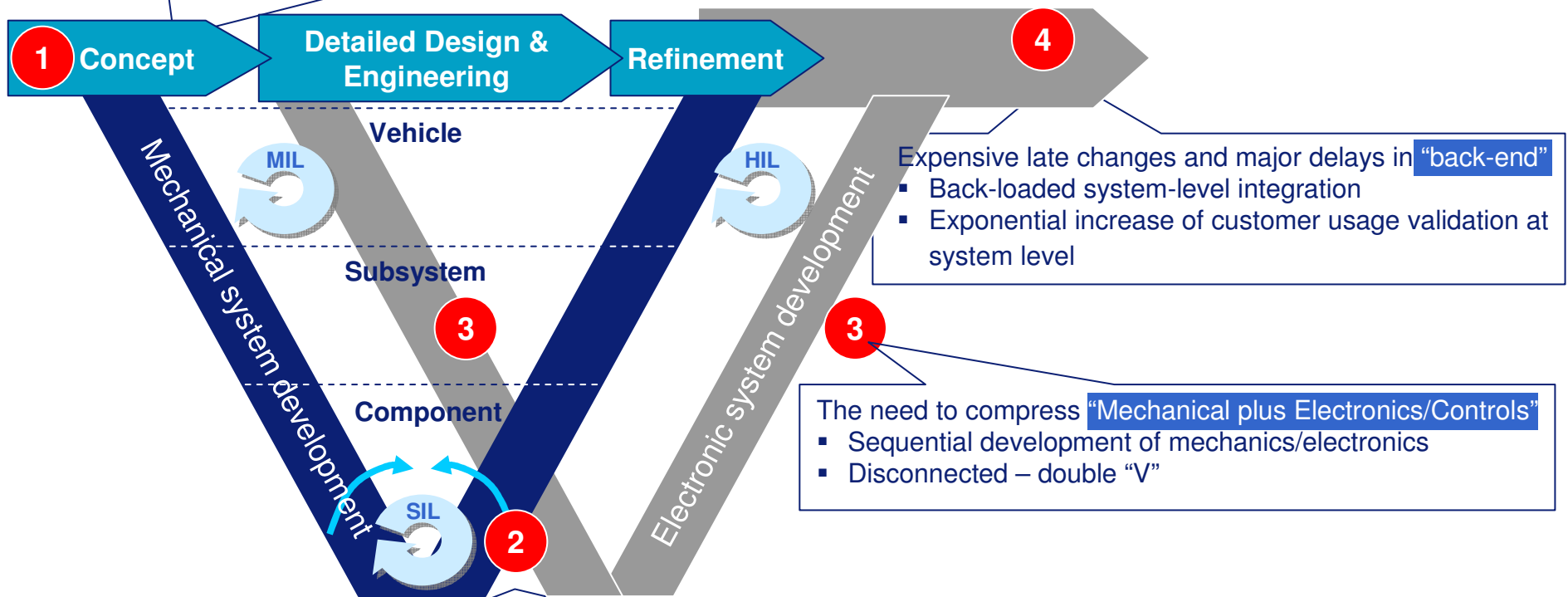
Ref. TOYOTA “zeronize / maximize”

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Major pain points in the current development process

Development process “front-end” facing major challenges

- Semi-empirical translation of multiple conflicting requirements and desired customer experiences into physical system specifications
- New customer – environmental – business drivers require new formal architecture design approaches



Expensive late changes and major delays in “back-end”

- Back-loaded system-level integration
- Exponential increase of customer usage validation at system level

The need to compress “Mechanical plus Electronics/Controls”

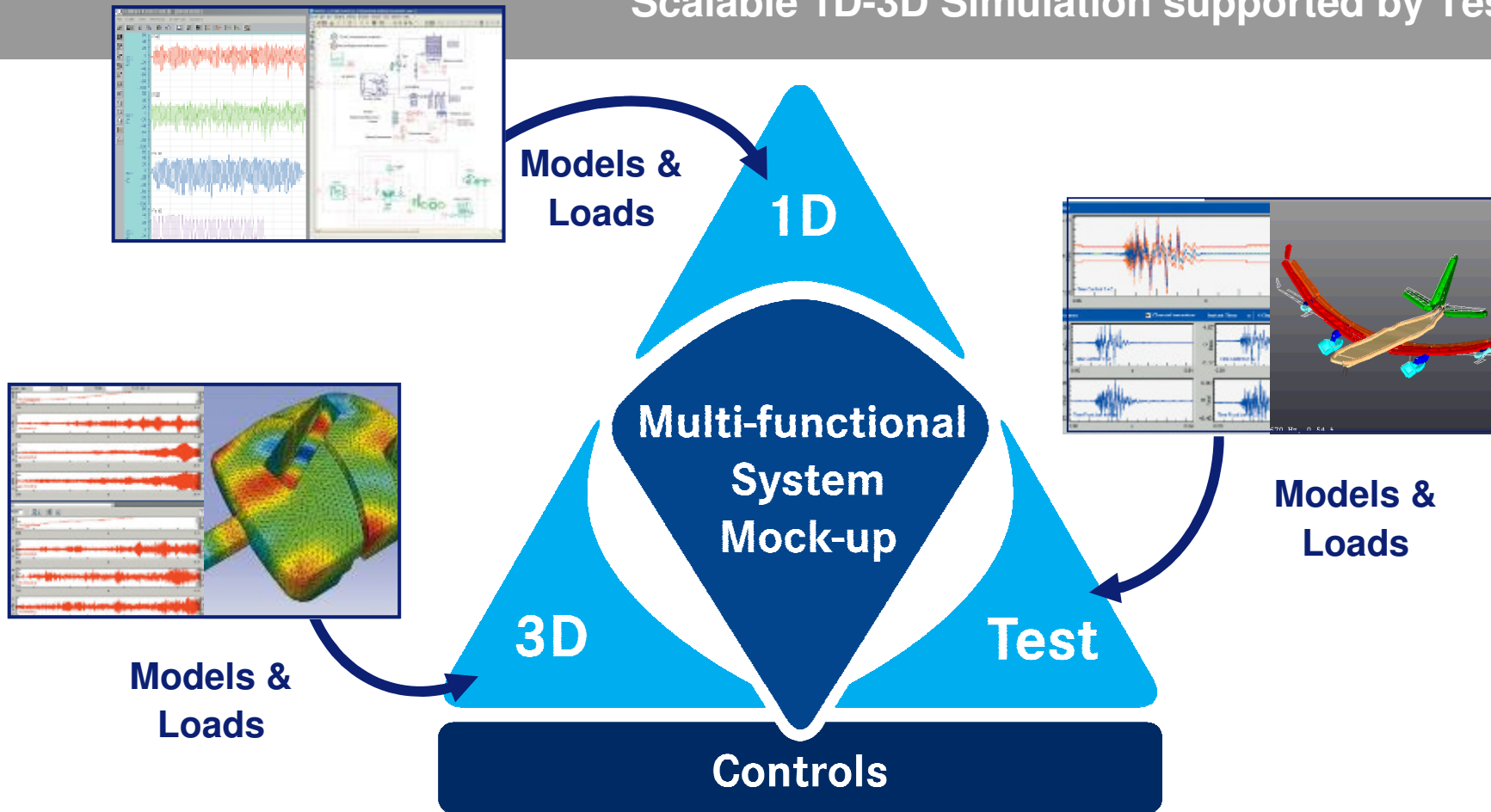
- Sequential development of mechanics/electronics
- Disconnected – double “V”

The need to accelerate, extend and enhance 3D CAE for detailed design

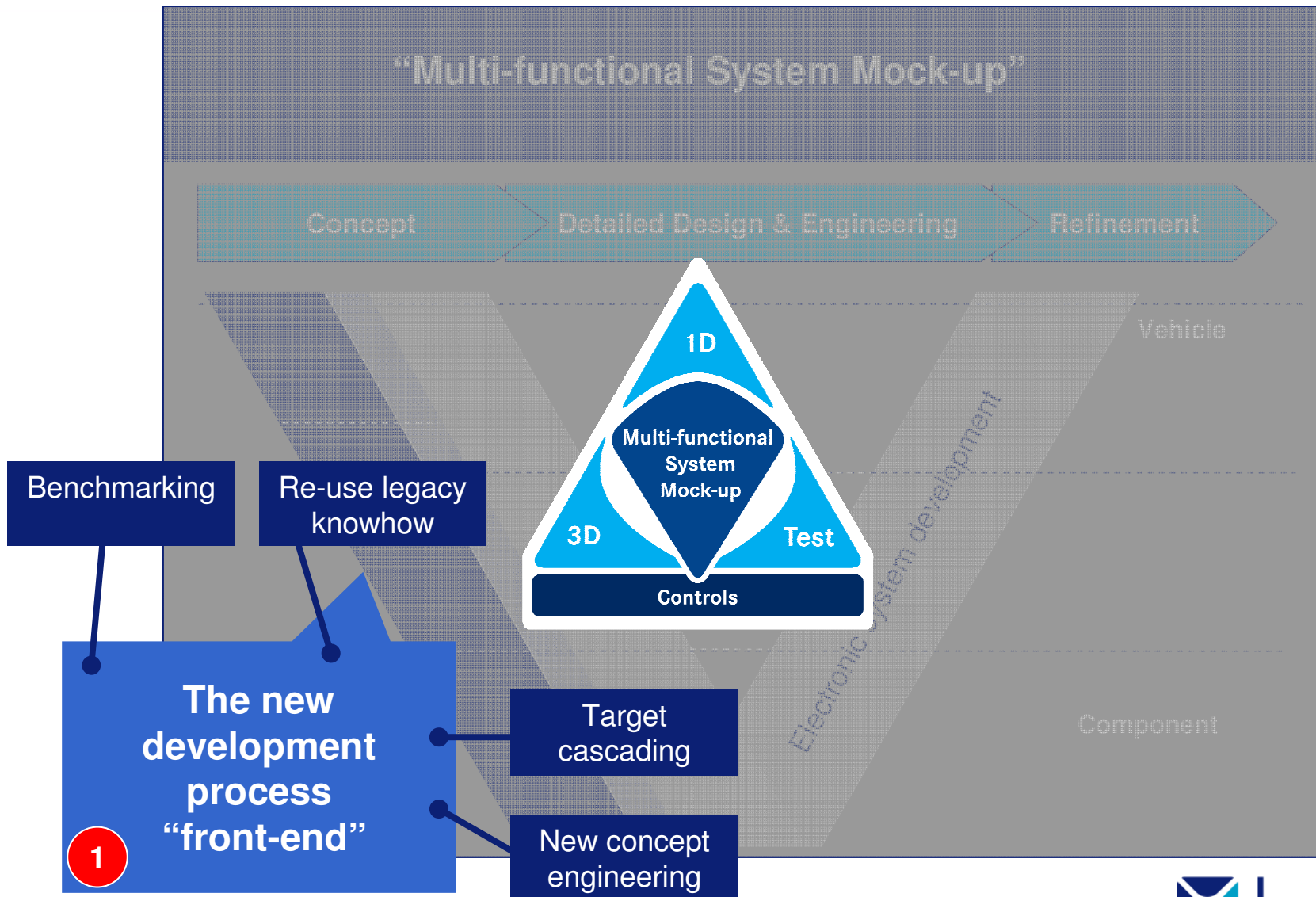
- Traditional 3D-CAE bottleneck by availability of 3D-design
- 3D-CAE stretched and technology curve flattening out

Redefining system-level simulation with the based on Multi-Functional System Mock-Up

Scalable 1D-3D Simulation supported by Test

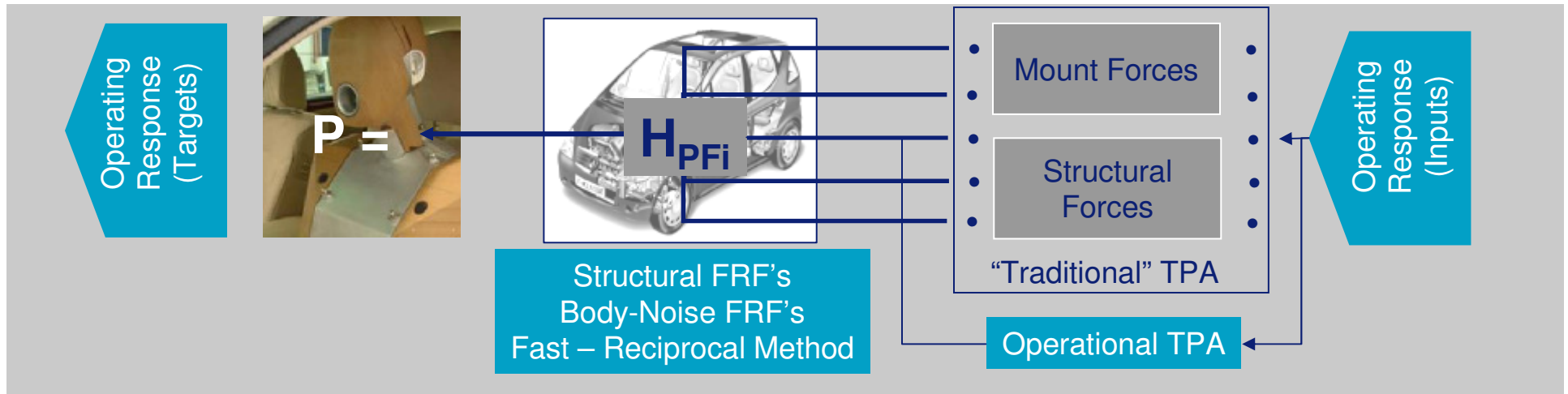


The next generation development process “front-end”



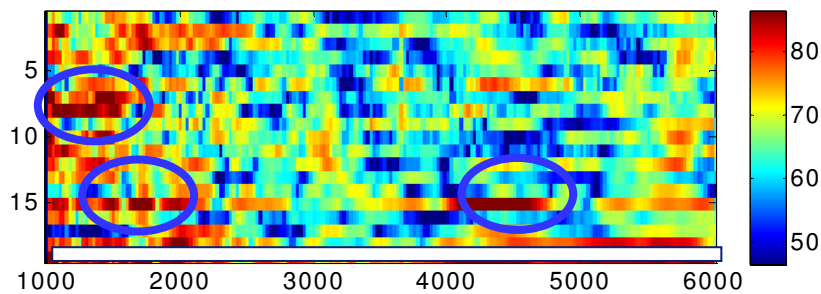
Benchmarking and Test-Based “front-end”

Target setting and target cascading – Transfer Path Analysis



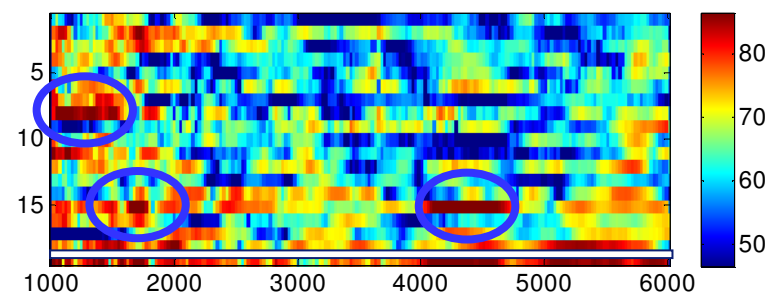
Traditional TPA

- Requires force transmissibility functions (mounts, attachment FRF's)



Operational TPA

- Direct estimation of forces based on operational inputs - **Patent Pending**

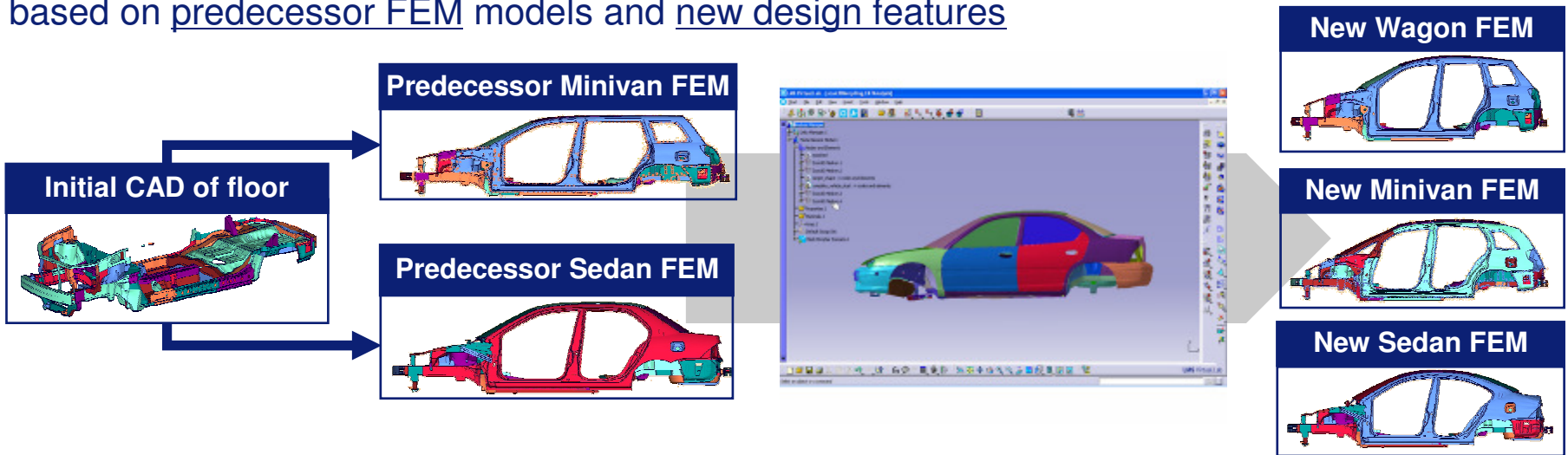


Operational TPA = same insights as Traditional TPA

Time saving: 80%

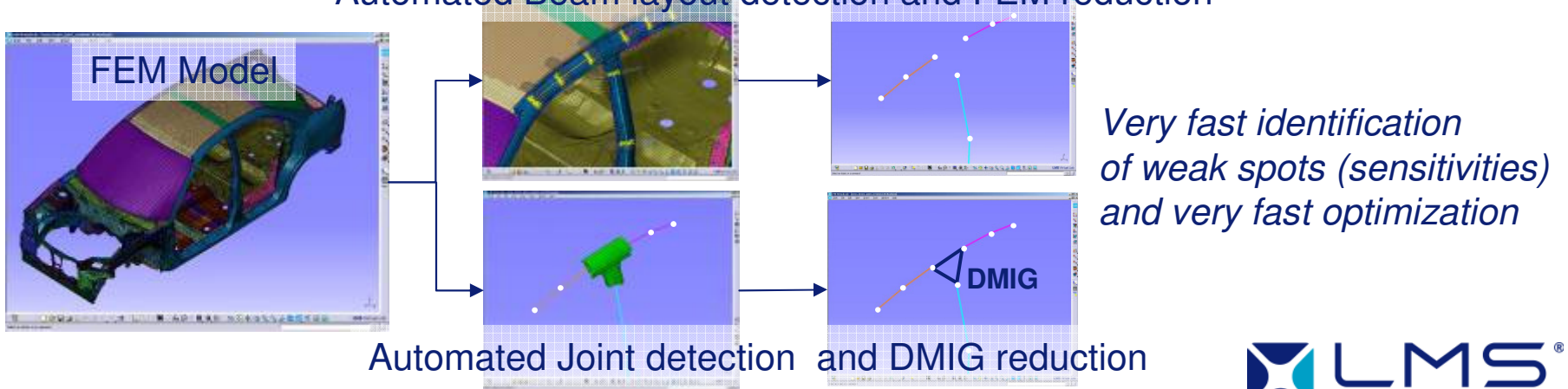
3D-CAE Based “front-end” Re-use of 3D simulation models for early analysis

Example: FEM Morphing Generate new FEM models based on predecessor FEM models and new design features



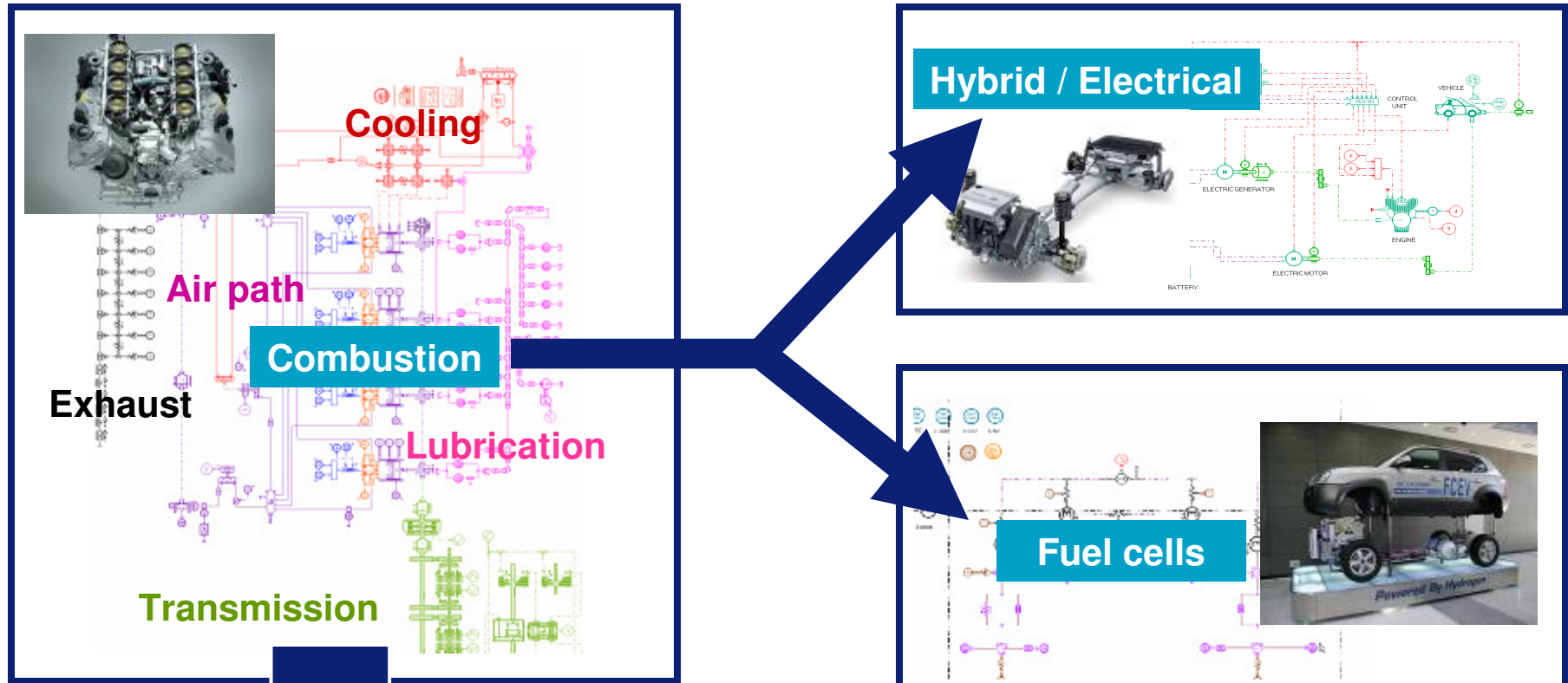
Example: Beam/Joined Modeling Technology

Automated Beam layout detection and FEM reduction



The next generation development process “front-end” System concept engineering – Based on 1D system simulation

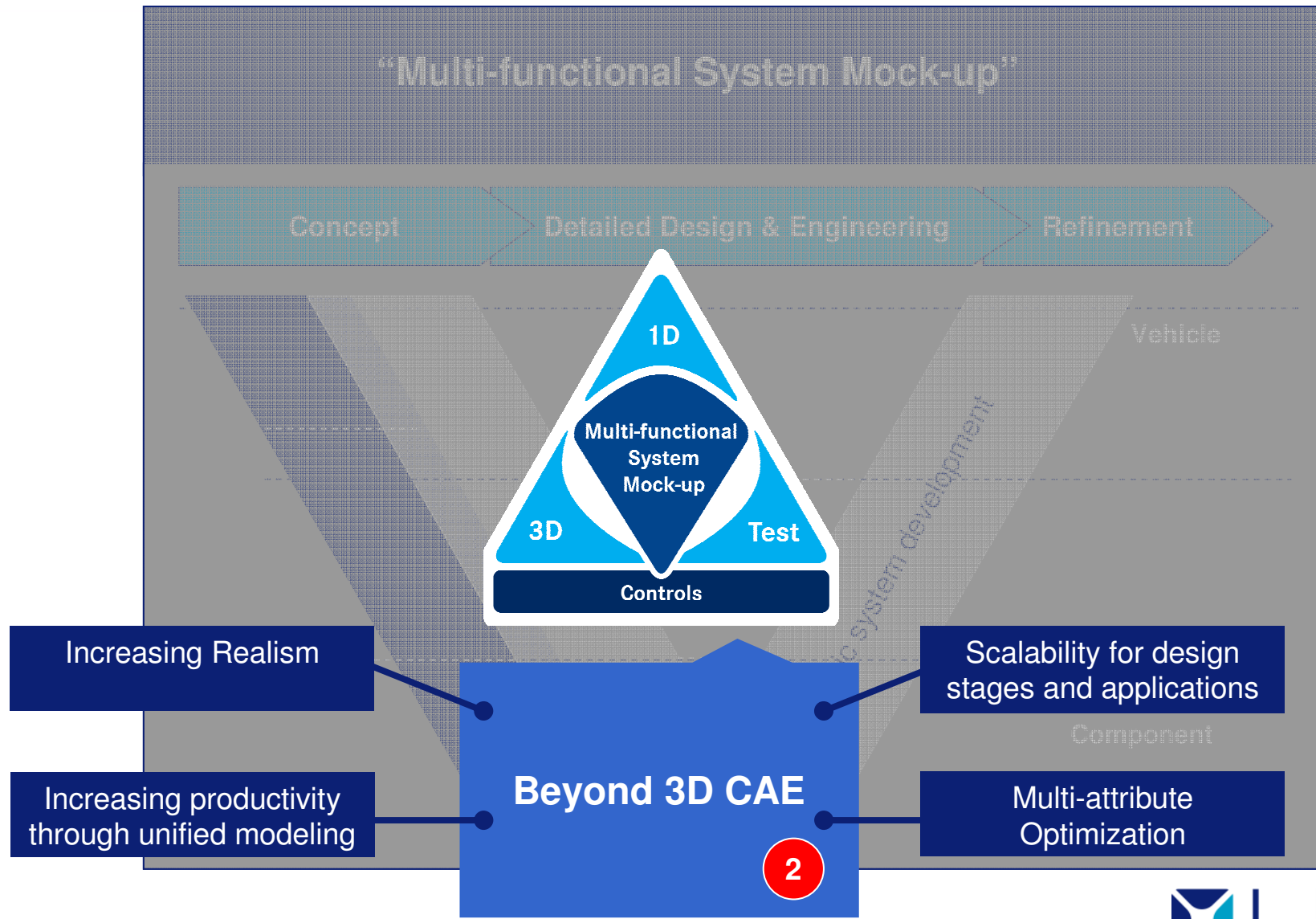
Example: study of new concepts for engines/powertrains
Based on multi-functional system mock-up and simulation



Engineer to be eco-friendly
and to meet “brand” image - performance



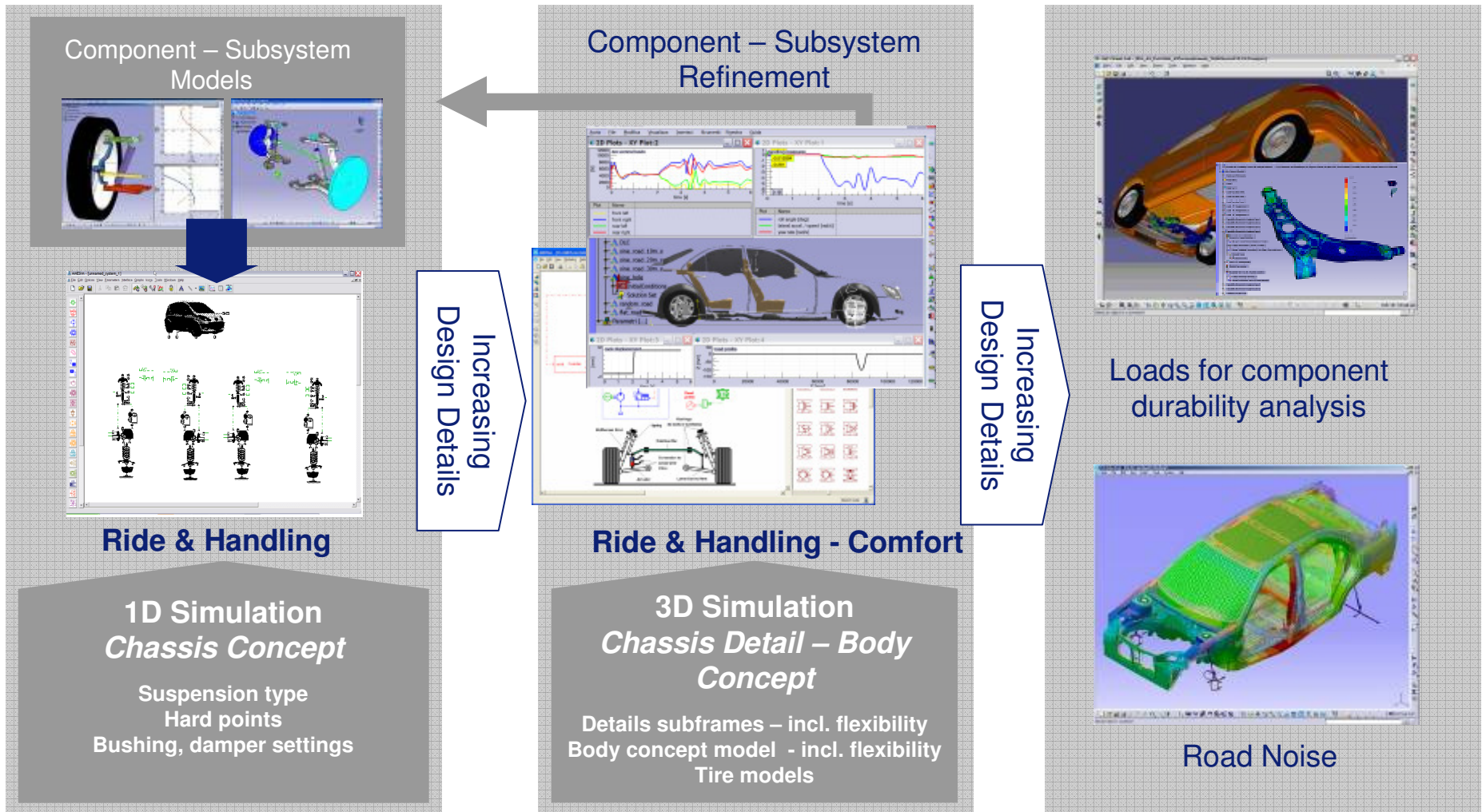
Beyond traditional 3D CAE



Beyond traditional 3D CAE

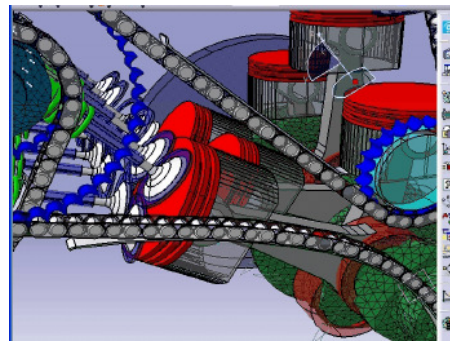
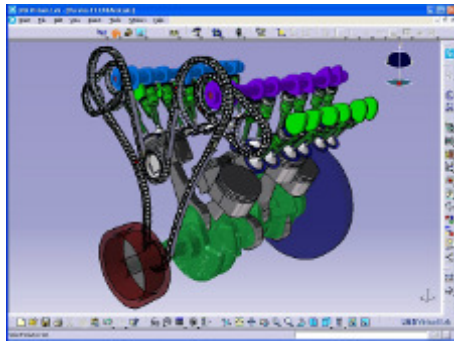
Scalable 1D/3D CAE for different design stages & simulation purposes

Example: vehicle dynamics engineering



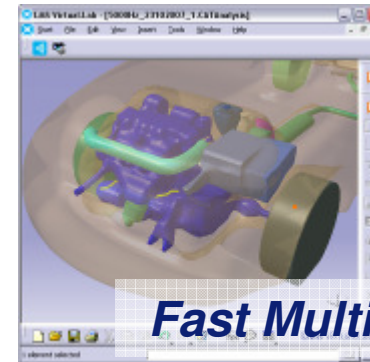
Improving realism for system level simulation

Advancing 3D simulation

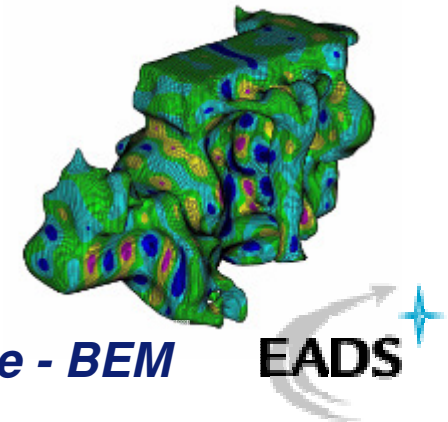


- ✓ Accurate modeling of interaction between subsystems to simulate loads, and load propagation

- ✓ Extending the “frequency” range:
 - High frequency noise sources: Injectors, modeling of engine bay
 - Higher frequency noise radiation
Simulation at +500 Hz



Fast Multipole - BEM



EC FWP 6 – Grid Computing Initiative
Data Grids for Process and Product Development
using Numerical Simulation and Knowledge Discovery

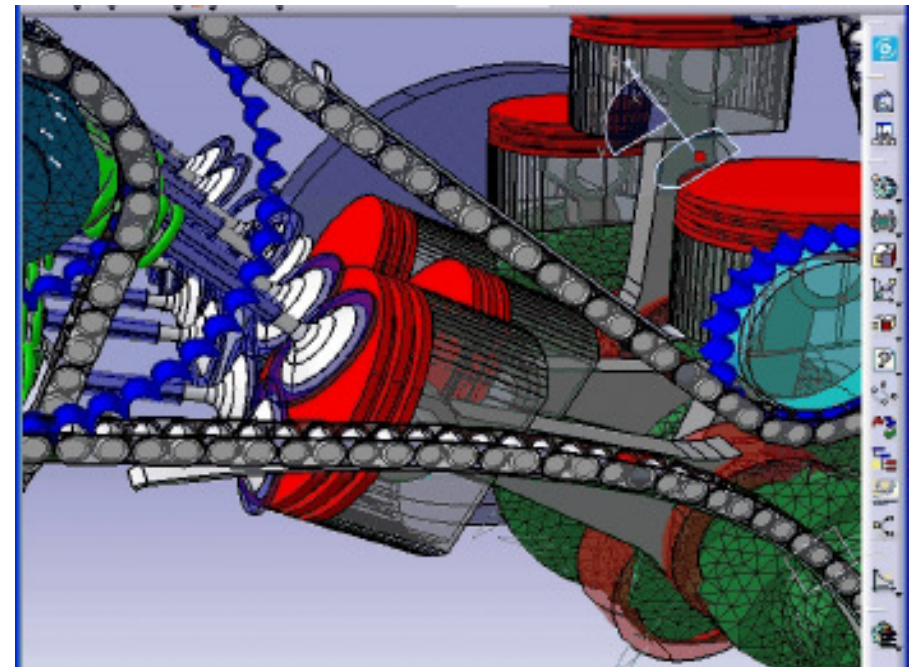
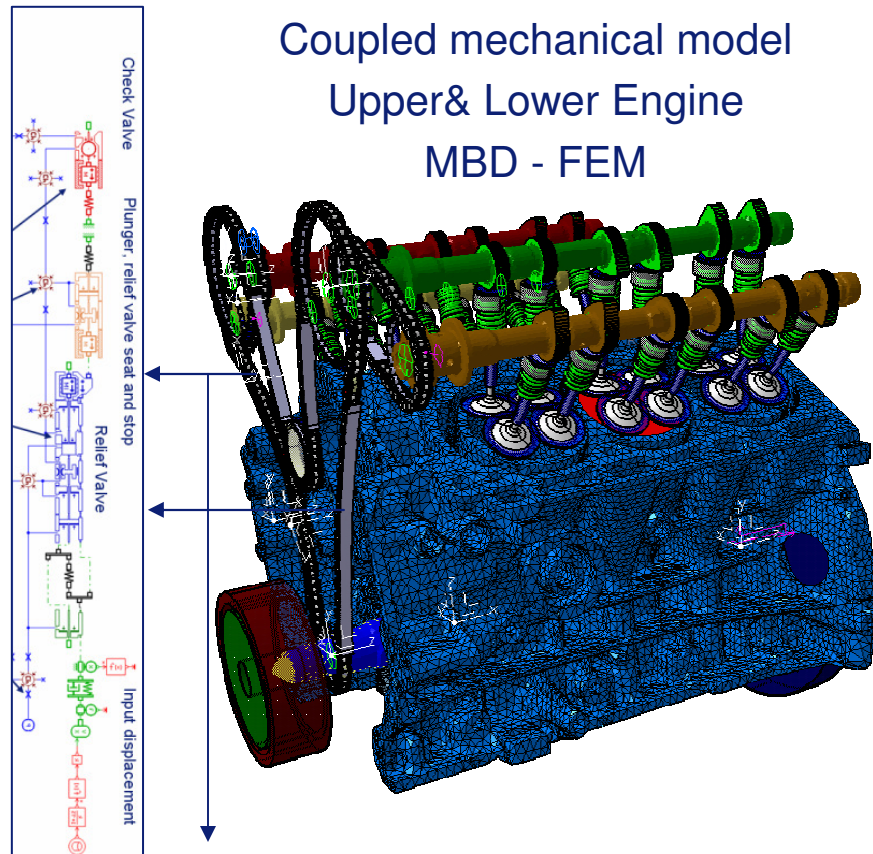


- ✓ Make use of continuous progress with computing
 - Multi-CPU computation
 - Grid computing



Improving realism for system level simulation Based on combination of 1D and 3D

Example: chain whine



Coupled simulation with
functional model for
chain tensioner / actuator

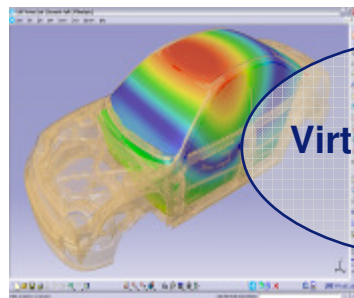
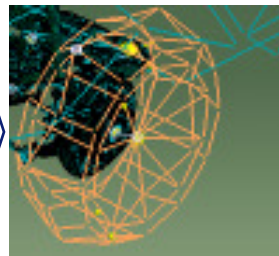
Improving realism for system level simulation Based on combined use of Test and CAE

Realistic Simulation

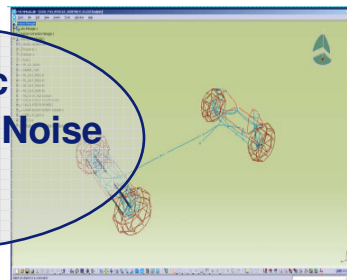
Example: Test Based Tire Model for Road Noise Simulation



Test Based
Virtual Tire



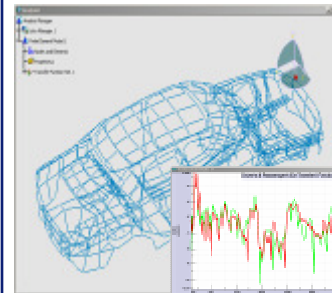
Realistic
Virtual Road Noise
Model



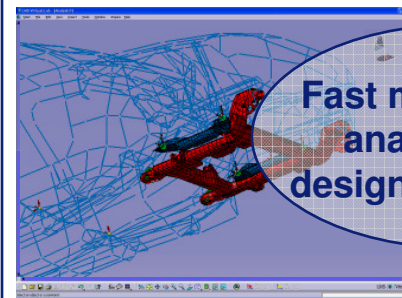
Vehicle Dynamics Model for Road Noise

Accelerated Refinement

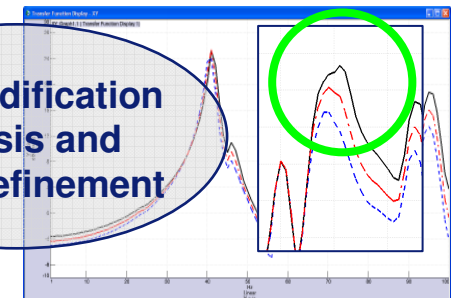
Example: Test Based Trimmed Body Model



Test
Based
Trimmed
Body



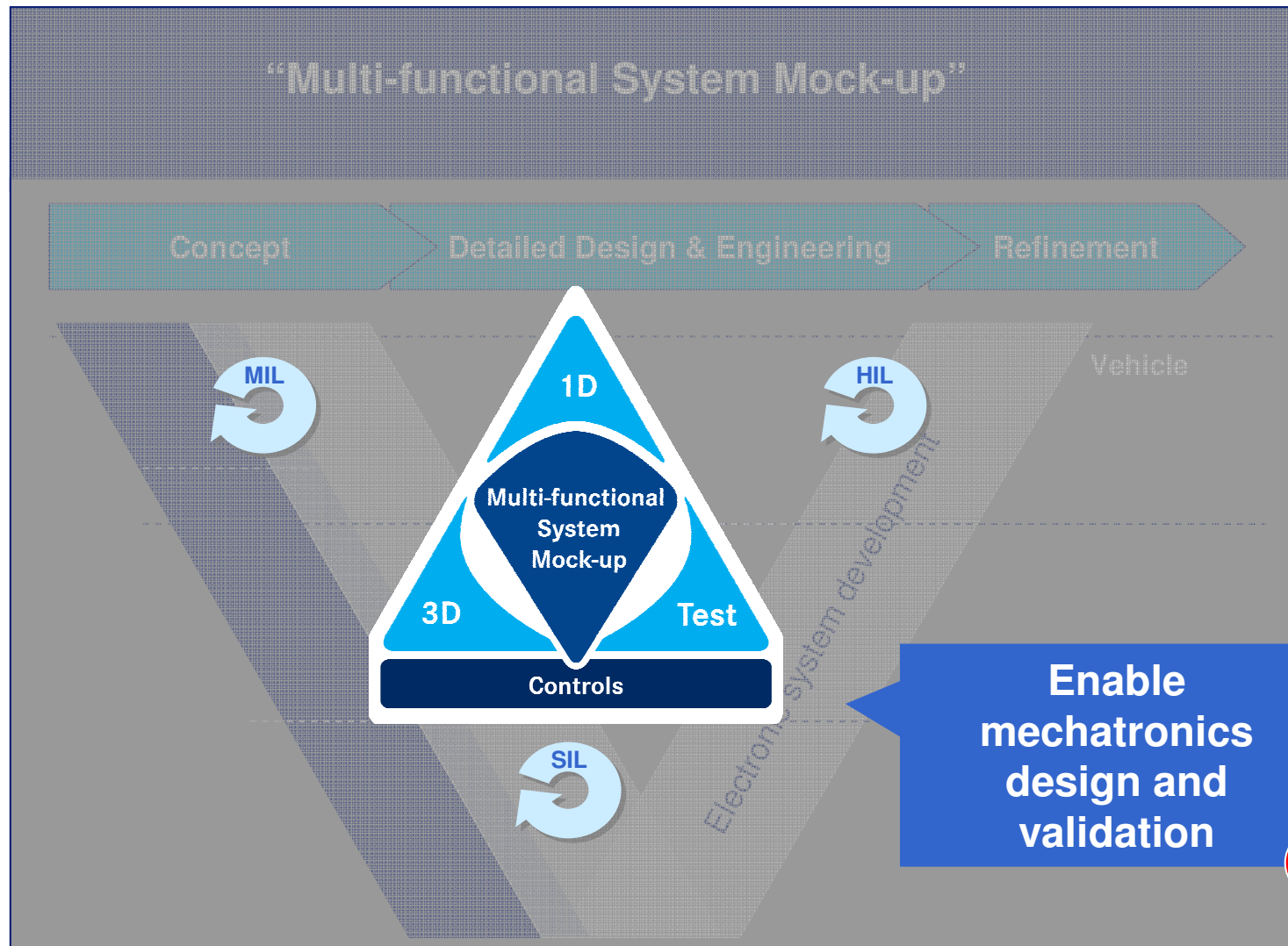
Fast modification
analysis and
design refinement



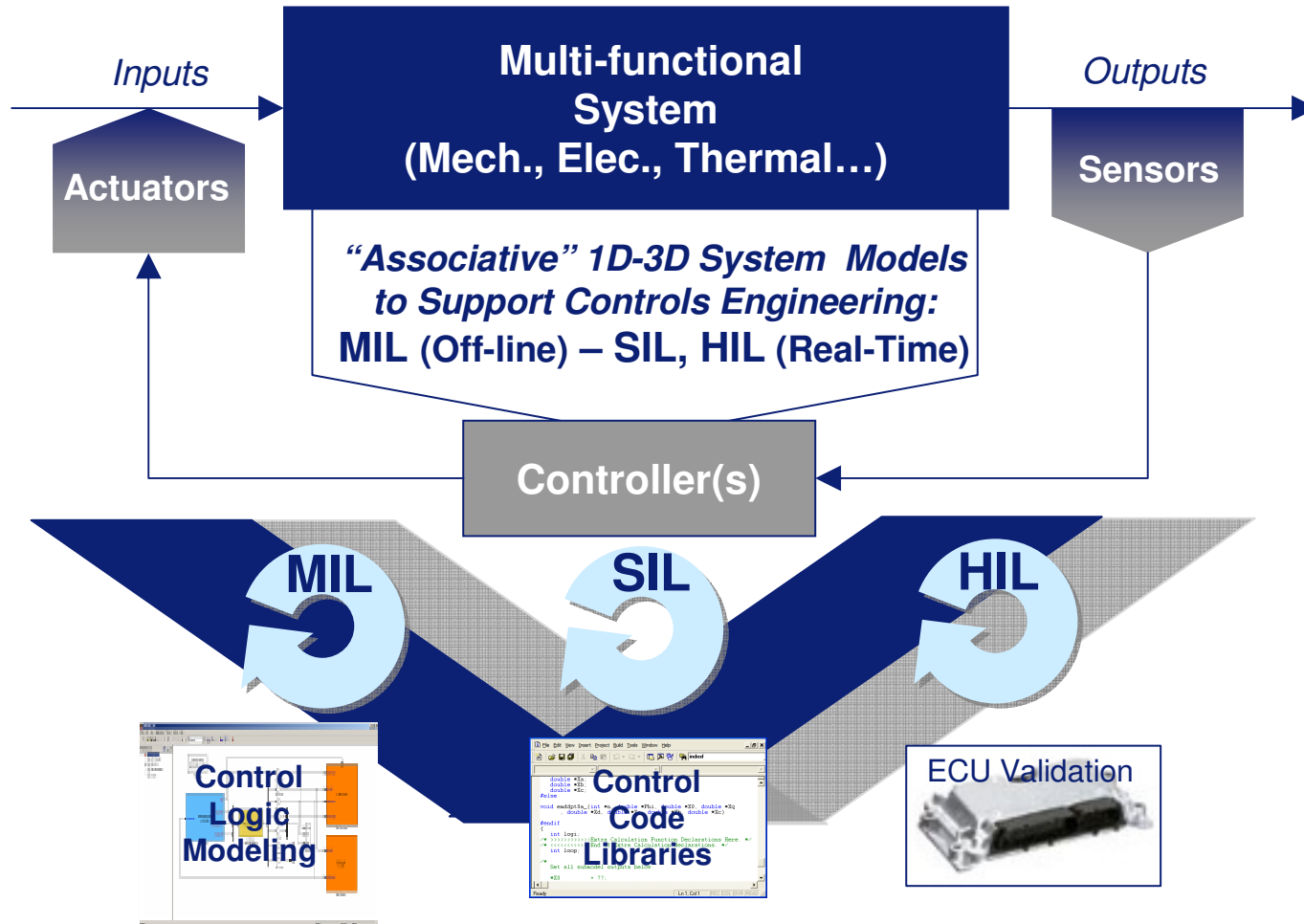
Test – CAE Substructuring

Measurement and analysis innovation – in support of simulation

Enabling mechatronics design and validation



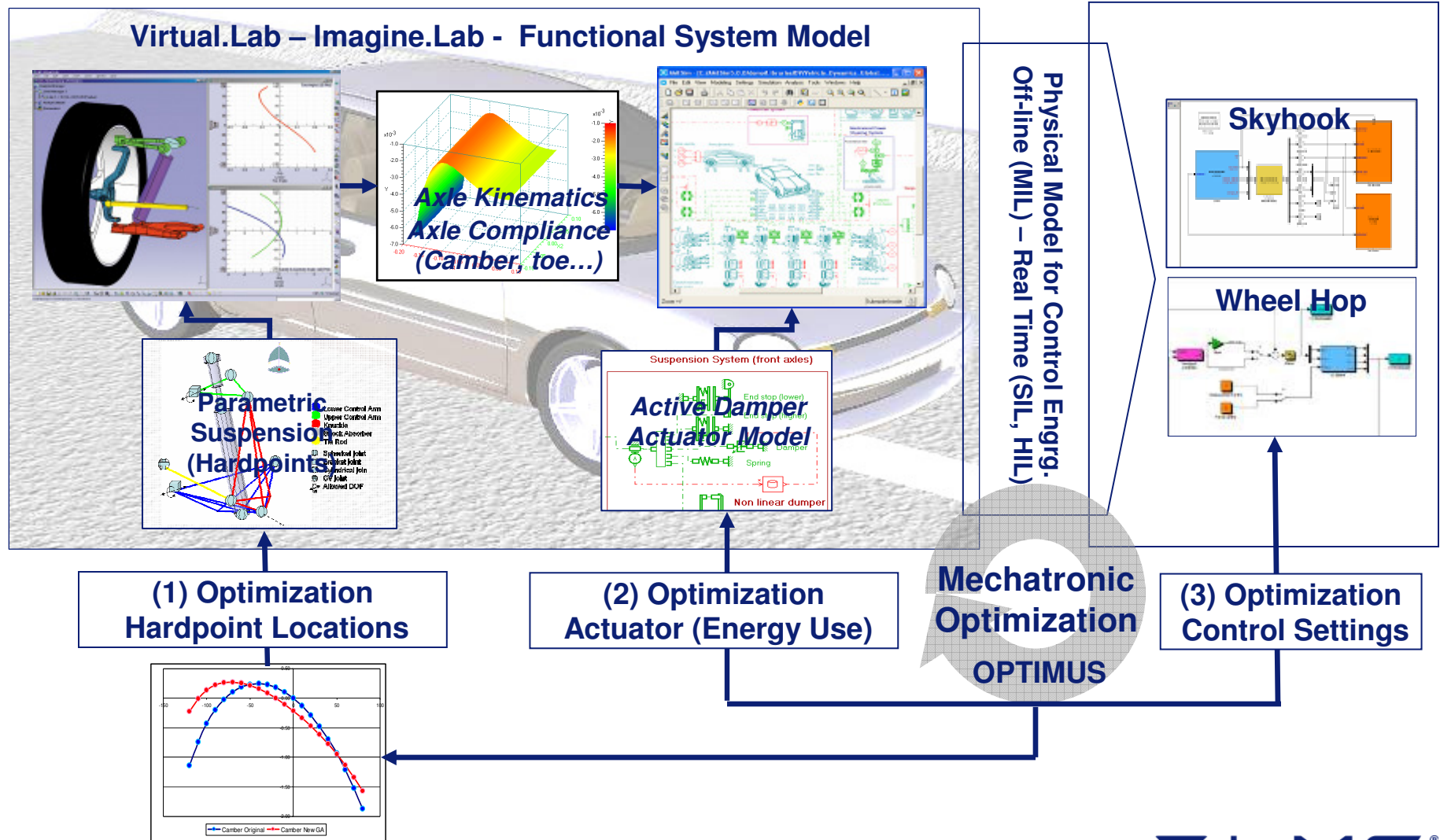
Enable mechatronic design and validation



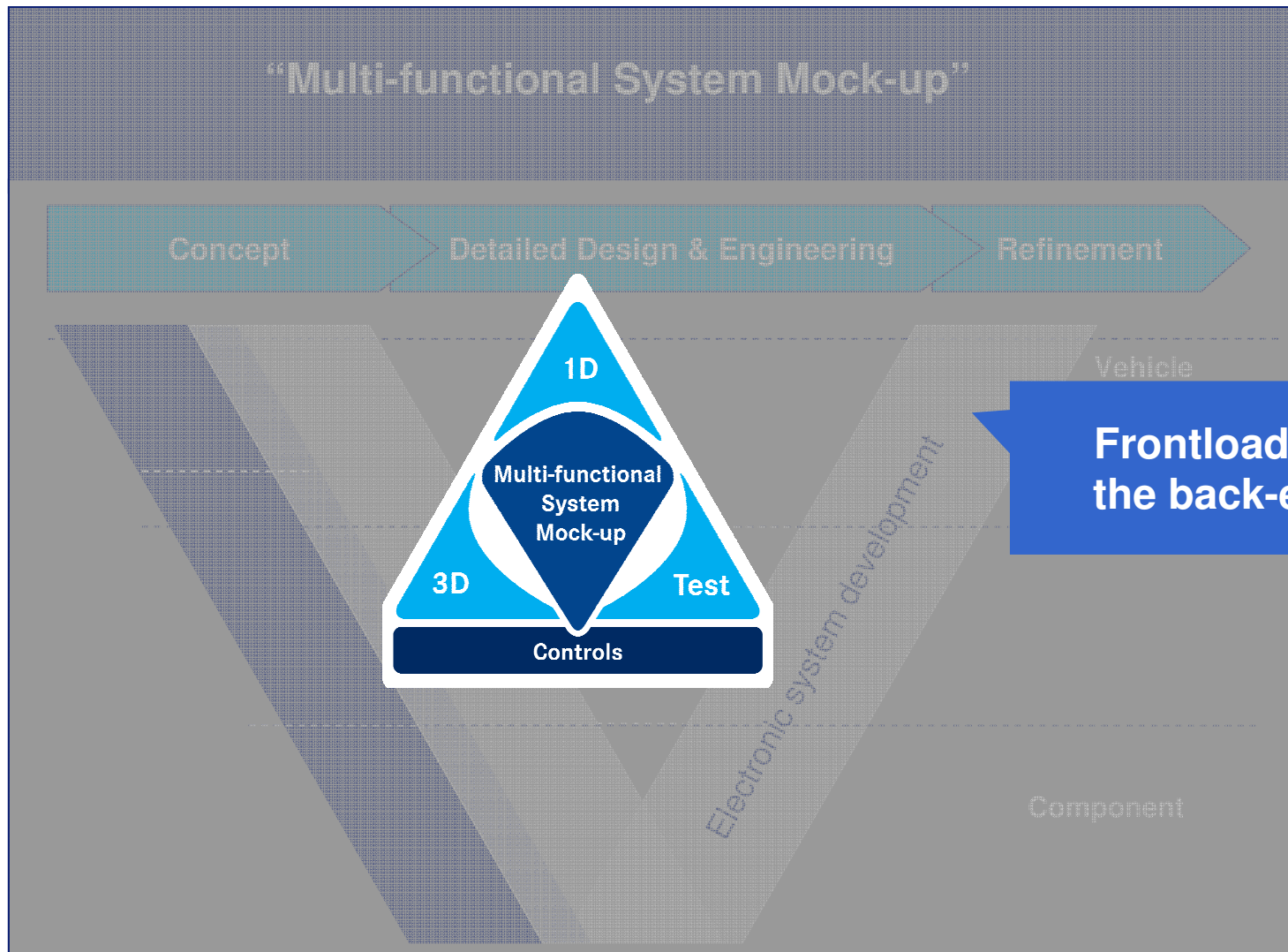
**Associative 1D-3D system models
to interconnect mechanical and electronics/control engineering**

Mechatronic system optimization

Joint performance and energy optimization in active suspension



Frontloading the development process “back-end”

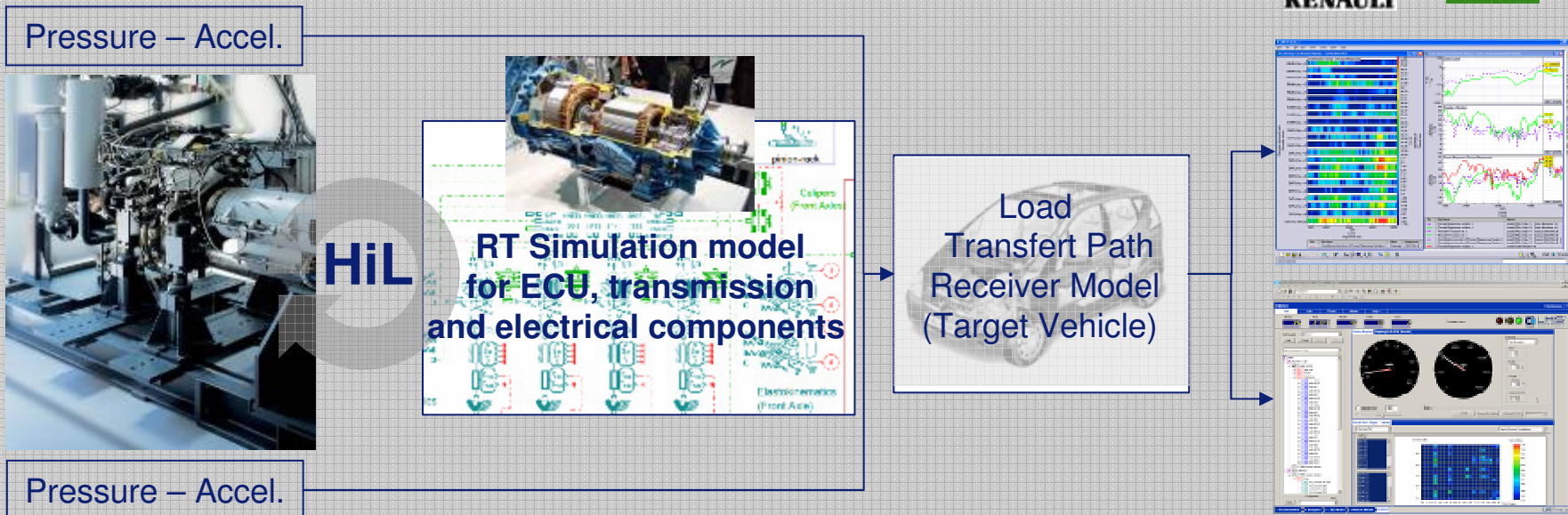


Frontloading the back-end 4

Frontloading validation and physical testing Enabled by the multi-functional system mock up

- Simulate on the test cell the “working” of target build-in environment
- Process and analyze test cell data in context of target build-in environment

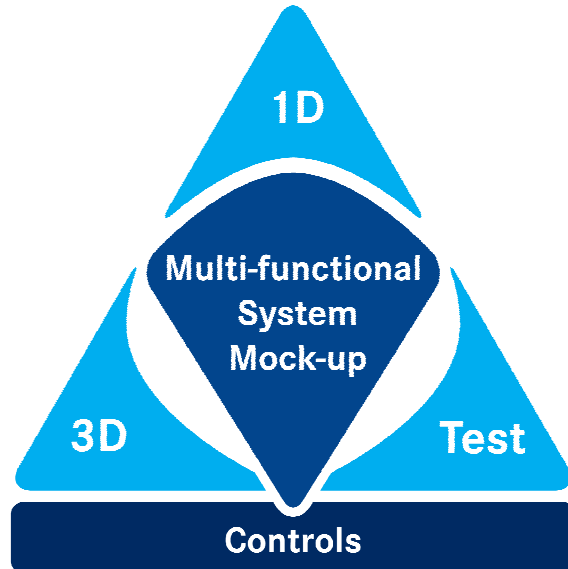
Example: testing and calibration of ICE to be used in hybrid powertrain



Simulation is key to enable frontloading of testing and validation

Conclusion

Increasing the impact of system simulation in all phases of development process based on Multi-functional System Mock-up



1D, 3D, Test – Functional Domain

- Continuous innovation
Simulation (1D, 3D) and Test
- Use progress in computing
Multi-CPU, Grid computing

Multifunctional System Mock-up

- “Combined” solutions
1D-3D Simulation
Simulation -Test
- “Physics” Models for Control

Empowering² the Next Generation Development Process



Thank you